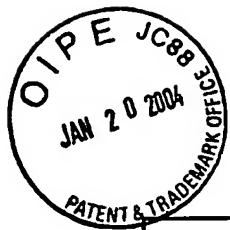




SHEET 1 OF 1

FORM PTO - 1449 SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT					ATTORNEY DOCKET NO.: ASC-058B APPLICANTS: Leitz <i>et al.</i> SERIAL NO.: 10/646,353 FILING DATE: August 22, 2003 GROUP: 2826				
U.S. PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME		CLASS	SUB CLASS	FILING DATE IF APPROPRIATE	
FOREIGN PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
<i>PJ</i>	B52	02/13262	02/14/2002	WO				N	Y
<i>JV</i>	B53	03/105189	12/18/2003	WO				N	Y
<i>JV</i>	B54	0 353 423	02/07/1990	EP				N	Y
<i>ZV</i>	B55	1 014 431	06/28/2000	EP				Y	N
OTHER ART, JOURNAL ARTICLES, ETC.									
EXAM. INIT.	OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)								
<i>PJ</i>	C136	International Search Report for International Patent Application No. PCT/US03/26467, dated July 13, 2004, 3 pages.							
<i>ZV</i>	C137	Luo <i>et al.</i> , "Compliant effect of low-temperature Si buffer for SiGe growth," <i>Applied Physics Letters</i> , 78(4):454-456 (2001).							
<i>PJ</i>	C138	Vyatkin <i>et al.</i> , "Study of Strain Relaxation in Epitaxial Structure GE _{0.2} Si _{0.8} /Si At Thermo-Implantation Treatment by Ion Beam Channeling," <i>Mat. Res. Soc. Symp. Proc.</i> , 585:183-189 (2000).							
EXAMINER	<i>Keith Quinby</i>			DATE CONSIDERED		<i>2/15/07</i>			

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SHEET 1 OF 1

FORM PTO - 1449 SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT					ATTORNEY DOCKET NO.: ASC-058B APPLICANTS: Leitz <i>et al.</i> SERIAL NO.: 10/646,353 FILING DATE: August 22, 2003 GROUP: 2811 2824				
U.S. PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE		
PL	A176	5,387,796	02/07/1995	Joshi <i>et al.</i>					
PL	A177	5,434,102	07/18/1995	Watanabe <i>et al.</i>					
FOREIGN PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
PL	B49	2-210816	08/22/1990	JP				N	Abstract
PL	B50	3-36717	02/18/1991	JP				N	Abstract
PL	B51	61-14116	06/28/1986	JP				N	Abstract
OTHER ART, JOURNAL ARTICLES, ETC.									
EXAM. INIT.	OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)								
PL	C132	Feichtinger <i>et al.</i> , "Misfit Dislocation Nucleation Study in p/p+ Silicon," <u>Journal of the Electrochemical Society</u> , 148 (7) (2001), pp. G379-G382.							
	C133	Grillot <i>et al.</i> , "Acceptor diffusion and segregation in (Al _x Ga _{1-x}) _{0.5} In _{0.5} P heterostructures," <u>Journal of Applied Physics</u> , Vol. 91, No. 8 (April 15, 2002), pp. 4891-4899.							
✓	C134	Hsu <i>et al.</i> , "Surface morphology of related Ge _x Si _{1-x} films," <u>Applied Physics Letters</u> , 61 (11) (September 14, 1992), pp. 1293-1295.							
PL	C135	"How to Make Silicon," Wacker University, http://www.wafernet.com/PresWK/h-ptl-as3_wsc_siltronic_com_pages_training_pages_Silic... , August 28, 2002.							
EXAMINER	Keith Dantz			DATE CONSIDERED				2/15/07	

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INFORMATION DISCLOSURE STATEMENT

ATTORNEY DOCKET NO.: ASC-058B

APPLICANT(S): Leitz *et al.*

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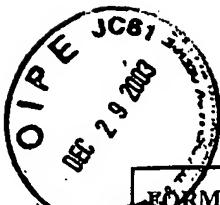
FILING DATE: August 22, 2003 GROUP: 2811

U.S. PATENT DOCUMENTS

EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
ZFL	A1	2001/0003364	06/14/2001	Sugawara <i>et al.</i>			
	A2	2001/0014570	08/16/2001	Wenski <i>et al.</i>			
	A3	2002/0043660	04/18/2002	Yamazaki <i>et al.</i>			
	A4	2002/0052084	05/02/2002	Fitzgerald			
	A5	2002/0084000	07/04/2002	Fitzgerald			
	A6	2002/0096717	07/25/2002	Chu <i>et al.</i>			
	A7	2002/0100942	08/01/2002	Fitzgerald <i>et al.</i>			
	A8	2002/0123167	09/05/2002	Fitzgerald			
	A9	2002/0123183	09/05/2002	Fitzgerald			
	A10	2002/0123197	09/05/2002	Fitzgerald <i>et al.</i>			
	A11	2002/0125471	09/12/2002	Fitzgerald <i>et al.</i>			
	A12	2002/0125497	09/12/2002	Fitzgerald			
	A13	2002/0168864	11/14/2002	Cheng <i>et al.</i>			
	A14	2002/0185686	12/12/2002	Christiansen <i>et al.</i>			
	A15	2003/0003679	01/02/2003	Doyle <i>et al.</i>			
	A16	2003/0013323	01/16/2003	Hammond <i>et al.</i>			
	A17	2003/0025131	02/06/2003	Lee <i>et al.</i>			
	A18	2003/0034529	02/20/2003	Fitzgerald <i>et al.</i>			
	A19	2003/0041798	03/06/2003	Wenski <i>et al.</i>			
	A20	2003/0057439	03/27/2003	Fitzgerald			
	A21	2003/0077867	04/24/2003	Fitzgerald			
	A22	2003/0102498	06/05/2003	Braithwaite <i>et al.</i>			
	A23	2003/0127646	07/10/2003	Christiansen <i>et al.</i>			
	A24	2003/0186073	10/02/2003	Fitzgerald			03/18/2003
ZFL	A25	4,010,045	03/01/1977	Ruehrwein			
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U.S. PATENT DOCUMENTS							
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE IF APPROPRIATE
109	A26	4,710,788	12/01/1987	Dambkes <i>et al.</i>			
	A27	4,900,372	12/13/1990	Lee <i>et al.</i>			
	A28	4,987,462	01/22/1991	Kim <i>et al.</i>			
	A29	4,990,979	02/05/1991	Otto			
	A30	4,997,776	03/05/1991	Harame <i>et al.</i>			
	A31	5,013,681	05/07/1991	Godbey <i>et al.</i>			
	A32	5,091,767	02/25/1992	Bean <i>et al.</i>			
	A33	5,097,630	03/24/1992	Maeda <i>et al.</i>			
	A34	5,155,571	10/13/1992	Wang <i>et al.</i>			
	A35	5,159,413	10/27/1992	Calviello <i>et al.</i>			
	A36	5,166,084	11/24/1992	Pfiester			
	A37	5,177,583	01/05/1993	Endo <i>et al.</i>			
	A38	5,202,284	04/13/1993	Kamins <i>et al.</i>			
	A39	5,207,864	05/04/1993	Bhat <i>et al.</i>			
	A40	5,208,182	05/04/1993	Narayan <i>et al.</i>			
	A41	5,210,052	05/11/1993	Takasaki			
	A42	5,212,110	05/18/1993	Pfiester <i>et al.</i>			
	A43	5,221,413	06/22/1993	Brasen <i>et al.</i>			
	A44	5,241,197	08/31/1993	Murakami <i>et al.</i>			
	A45	5,250,445	10/05/1993	Bean <i>et al.</i>			
	A46	5,252,173	10/12/1993	Inoue			
	A47	5,279,687	01/18/1994	Tuppen <i>et al.</i>			
	A48	5,285,086	02/08/1994	Fitzgerald			
	A49	5,291,439	03/01/1994	Kauffmann <i>et al.</i>			
109	A50	5,298,452	03/29/1994	Meyerson			
109	A51	5,308,444	05/03/1994	Fitzgerald <i>et al.</i>			
EXAMINER Kevin Dantz				DATE CONSIDERED 2/15/07			



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U.S. PATENT DOCUMENTS							
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
<i>PJ</i>	A52	5,310,451	05/10/1994	Tejwani <i>et al.</i>			
	A53	5,316,958	05/31/1994	Meyerson			
	A54	5,346,848	09/13/1994	Grupen- Shemansky <i>et al.</i>			
	A55	5,374,564	12/20/1994	Bruel			
	A56	5,399,522	03/21/1995	Ohori			
	A57	5,413,679	05/09/1995	Godbey			
	A58	5,424,243	06/13/1995	Takasaki			
	A59	5,425,846	06/20/1995	Koze <i>et al.</i>			
	A60	5,426,069	06/20/1995	Selvakumar <i>et al.</i>			
	A61	5,426,316	06/20/1995	Mohammad			
	A62	5,442,205	08/15/1995	Brasen <i>et al.</i>			
	A63	5,461,243	10/24/1995	Ek <i>et al.</i>			
	A64	5,461,250	10/24/1995	Burghartz <i>et al.</i>			
	A65	5,462,883	10/31/1995	Dennard <i>et al.</i>			
	A66	5,476,813	12/19/1995	Naruse			
	A67	5,479,033	12/26/1995	Baca <i>et al.</i>			
	A68	5,484,664	01/16/1996	Kitahara <i>et al.</i>			
	A69	5,523,243	06/04/1996	Mohammad			
	A70	5,523,592	06/04/1996	Nakagawa <i>et al.</i>			
	A71	5,534,713	07/09/1996	Ismail <i>et al.</i>			
	A72	5,536,361	07/16/1996	Kondo <i>et al.</i>			
	A73	5,540,785	07/30/1996	Dennard <i>et al.</i>			
	A74	5,596,527	01/21/1997	Tomioka <i>et al.</i>			
	A75	5,617,351	04/01/1997	Bertin <i>et al.</i>			
	A76	5,630,905	05/20/1997	Lynch <i>et al.</i>			
	A77	5,633,516	05/27/1997	Mishima <i>et al.</i>			
<i>PJ</i>	A78	5,659,187	08/19/1997	Legoues <i>et al.</i>			
EXAMINER	Kevin Quinto			DATE CONSIDERED	2/15/07		



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U.S. PATENT DOCUMENTS							
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
<i>PL</i>	A79	5,683,934	11/04/1997	Candelaria			
	A80	5,698,869	12/16/1997	Yoshimi <i>et al.</i>			
	A81	5,714,777	02/03/1998	Ismail <i>et al.</i>			
	A82	5,728,623	03/17/1998	Mori			
	A83	5,739,567	04/14/1998	Wong			
	A84	5,759,898	06/02/1998	Ek <i>et al.</i>			
	A85	5,777,347	07/07/1998	Bartelink			
	A86	5,786,612	07/28/1998	Otani <i>et al.</i>			
	A87	5,786,614	07/28/1998	Chuang <i>et al.</i>			
	A88	5,792,679	08/11/1998	Nakato			
	A89	5,801,085	09/01/1998	Kim <i>et al.</i>			
	A90	5,808,344	09/15/1998	Ismail <i>et al.</i>			
	A91	5,810,924	09/22/1998	Legoues <i>et al.</i>			
	A92	5,828,114	10/27/1998	Kim <i>et al.</i>			
	A93	5,847,419	12/08/1998	Imai <i>et al.</i>			
	A94	5,859,864	01/12/1999	Jewell			
	A95	5,877,070	03/02/1999	Goesele <i>et al.</i>			
	A96	5,891,769	04/06/1999	Liaw <i>et al.</i>			
	A97	5,906,708	05/25/1999	Robinson <i>et al.</i>			
	A98	5,906,951	05/25/1999	Chu <i>et al.</i>			
	A99	5,912,479	06/15/1999	Mori <i>et al.</i>			
	A100	5,943,560	08/24/1999	Chang <i>et al.</i>			
	A101	5,963,817	10/05/1999	Chu <i>et al.</i>			
	A102	5,966,622	10/12/1999	Levine <i>et al.</i>			
	A103	5,998,807	12/07/1999	Lustig <i>et al.</i>			
	A104	6,010,937	01/04/2000	Karam <i>et al.</i>			
	A105	6,013,134	01/11/2000	Chu <i>et al.</i>			
	A106	6,030,884	02/29/2000	Mori			
<i>PL</i>	A107	6,033,974	03/07/2000	Henley <i>et al.</i>			
EXAMINER	<i>Kevin Quinto</i>			DATE CONSIDERED	<i>2/5/07</i>		



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U.S. PATENT DOCUMENTS

EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	A108	6,033,995	03/07/2000	Muller			
	A109	6,039,803	03/21/2000	Fitzgerald <i>et al.</i>			
	A110	6,058,044	05/02/2000	Sugiura <i>et al.</i>			
	A111	6,059,895	05/09/2000	Chu <i>et al.</i>			
	A112	6,074,919	06/13/2000	Gardner <i>et al.</i>			
	A113	6,096,590	08/01/2000	Chan <i>et al.</i>			
	A114	6,103,559	08/15/2000	Gardner <i>et al.</i>			
	A115	6,107,653	08/22/2000	Fitzgerald			
	A116	6,111,267	08/29/2000	Fischer <i>et al.</i>			
	A117	6,117,750	09/12/2000	Bensahel <i>et al.</i>			
	A118	6,124,614	09/26/2000	Ryum <i>et al.</i>			
	A119	6,130,453	10/10/2000	Mei <i>et al.</i>			
	A120	6,133,799	10/17/2000	Favors <i>et al.</i>			
	A121	6,140,687	10/31/2000	Shimomura <i>et al.</i>			
	A122	6,143,636	11/07/2000	Forbes <i>et al.</i>			
	A123	6,153,495	11/28/2000	Kub <i>et al.</i>			
	A124	6,154,475	11/28/2000	Soref <i>et al.</i>			
	A125	6,160,303	12/12/2000	Fattaruso			
	A126	6,162,688	12/19/2000	Gardner <i>et al.</i>			
	A127	6,184,111	02/06/2001	Henley <i>et al.</i>			
	A128	6,191,006	02/20/2001	Mori			
	A129	6,191,007	02/20/2001	Matsui <i>et al.</i>			
	A130	6,191,432	02/20/2001	Sugiyama <i>et al.</i>			
	A131	6,194,722	02/27/2001	Fiorini <i>et al.</i>			
	A132	6,204,529	03/20/2001	Lung <i>et al.</i>			
	A133	6,207,977	03/27/2001	Augusto			
	A134	6,210,988	04/03/2001	Howe <i>et al.</i>			
	A135	6,218,677	04/17/2001	Broekaert			
	A136	6,232,138	05/15/2001	Fitzgerald <i>et al.</i>			
	A137	6,235,567	05/22/2001	Huang			
EXAMINER	<i>Kevin Dunn</i>			DATE CONSIDERED	<i>2/15/07</i>		



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U.S. PATENT DOCUMENTS

EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
✓	A138	6,242,324	06/05/2001	Kub <i>et al.</i>			
	A139	6,249,022	06/19/2001	Lin <i>et al.</i>			
	A140	6,251,755	06/26/2001	Furukawa <i>et al.</i>			
	A141	6,261,929	07/17/2001	Gehrke <i>et al.</i>			
	A142	6,266,278	07/24/2001	Harari <i>et al.</i>			
	A143	6,271,551	08/07/2001	Schmitz <i>et al.</i>			
	A144	6,271,726	08/07/2001	Fransis <i>et al.</i>			
	A145	6,291,321	09/18/2001	Fitzgerald			
	A146	6,313,016	11/06/2001	Kibbel <i>et al.</i>			
	A147	6,316,301	11/13/2001	Kant			
	A148	6,323,108	11/27/2001	Kub <i>et al.</i>			
	A149	6,329,063	12/11/2001	Lo <i>et al.</i>			
	A150	6,335,546	01/01/2002	Tsuda <i>et al.</i>			
	A151	6,339,232	01/15/2002	Takagi			
	A152	6,350,993	02/26/2002	Chu <i>et al.</i>			
	A153	6,368,733	04/09/2002	Nishinaga			
	A154	6,372,356	04/16/2002	Thornton <i>et al.</i>			
	A155	6,399,970	06/04/2002	Kubo <i>et al.</i>			
	A156	6,403,975	06/11/2002	Brunner <i>et al.</i>			
	A157	6,406,589	06/18/2002	Yanagisawa			
	A158	6,407,406	06/18/2002	Tezuka			
	A159	6,420,937	07/16/2002	Akatsuka <i>et al.</i>			
	A160	6,425,951	07/30/2002	Chu <i>et al.</i>			
	A161	6,429,061	08/06/2002	Rim			
	A162	6,482,749	11/19/2002	Billington <i>et al.</i>			
	A163	6,503,773	01/07/2003	Fitzgerald			
✓	A164	6,515,335	02/04/2003	Christiansen <i>et al.</i>			
✓	A165	6,518,644	02/11/2003	Fitzgerald			
EXAMINER	Keith Quinto		DATE CONSIDERED	2/5/07			



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U.S. PATENT DOCUMENTS

EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
<i>PZ</i>	A166	6,521,041	02/18/2003	Wu et al.			
	A167	6,525,338	02/25/2003	Mizushima et al.			
	A168	6,555,839	04/29/2003	Fitzgerald			
	A169	6,573,126	06/03/2003	Cheng et al.			
	A170	6,576,532	06/10/2003	Jones et al.			
	A171	6,583,015	06/24/2003	Fitzgerald et al.			
	A172	6,593,191	07/15/2003	Fitzgerald			
<i>V</i>	A173	6,594,293	07/15/2003	Bulsara et al.			
<i>V</i>	A174	6,602,613	08/05/2003	Fitzgerald			
<i>PZ</i>	A175	6,603,156	08/05/2003	Rim			

FOREIGN PATENT DOCUMENTS

EXAM. INIT.		DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
<i>PZ</i>	B1	41 01 167	07/23/1992	DE				N	Abstract
	B2	0 514 018	11/19/1992	EP				N	Y
	B3	0 587 520	03/16/1994	EP				N	Y
	B4	0 683 522	11/22/1995	EP				N	Y
	B5	0 828 296	03/11/1998	EP				N	Y
	B6	0 829 908	03/18/1998	EP				N	Y
	B7	0 838 858	04/29/1998	EP				N	Abstract
	B8	1 020 900	07/19/2000	EP				N	Y
	B9	1 174 928	01/23/2002	EP				N	Y
<i>V</i>	B10	2 342 777	04/19/2000	GB				Y	Y
<i>PZ</i>	B11	4-307974	10/30/1992	JP				N	Abstract

EXAMINER	Kevin Quin h	DATE CONSIDERED	2/15/07
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FORM PTO - 1449 INFORMATION DISCLOSURE STATEMENT				ATTORNEY DOCKET NO.: ASC-058B APPLICANT(S): Leitz <i>et al.</i> SERIAL NO.: 10/646,353 FILING DATE: August 22, 2003 GROUP: 2811					
FOREIGN PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
<i>PJ</i>	B12	5-166724	07/02/1993	JP				N	Abstract
	B13	6-177046	06/24/1994	JP				N	Abstract
	B14	6-244112	09/02/1994	JP				Y	Y
	B15	6-252046	09/09/1994	JP				Y	Y
	B16	7-94420	04/07/1995	JP				N	Abstract
	B17	7-106446	04/21/1995	JP				N	Abstract
	B18	7-240372	09/12/1995	JP				N	Abstract
	B19	10-270685	10/09/1998	JP				N	Y
	B20	11-233744	08/27/1999	JP				N	Abstract
	B21	63-73398	04/02/1988	JP				N	N
	B22	2000-021783	01/21/2000	JP				N	Y
	B23	2000-031491	01/28/2000	JP				N	Y
	B24	2000-513507	10/10/2000	JP				Y	Y
	B25	2001-319935	11/16/2001	JP				N	Y
	B26	2002-076334	03/15/2002	JP				N	Y
	B27	2002-164520	06/07/2002	JP				N	Y
	B28	2002-289533	10/04/2002	JP				N	Y
	B29	2002-356399	12/13/2002	JP				N	Y
	B30	2003-520444	07/02/2003	JP				N	Abstract
	B31	98/59365	12/30/1998	WO				N	Y
	B32	99/53539	10/21/1999	WO				N	Y
	B33	00/48239	08/17/2000	WO				N	Y
	B34	00/54338	09/14/2000	WO				N	Y
<i>JG</i>	B35	01/022482	03/29/2001	WO				N	Y
<i>JG</i>	B36	01/54175	07/26/2001	WO				N	Y
EXAMINER <i>Keith Quirk</i>				DATE CONSIDERED <i>2/15/07</i>					



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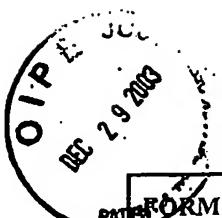
FOREIGN PATENT DOCUMENTS

EXAM. INIT.		DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
<i>M</i>	B37	01/54202	07/26/2001	WO				N	Y
	B38	01/93338	12/06/2001	WO				N	Y
	B39	01/99169	12/27/2001	WO				N	Y
	B40	02/071488	09/12/2002	WO				N	Y
	B41	02/071491	09/12/2002	WO				N	Y
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	B43	02/082514	10/17/2002	WO				N	Y
	B44	02/13262	02/14/2002	WO				N	Y
	B45	02/15244	02/21/2002	WO				N	Y
<i>V</i>	B46	02/27783	04/04/2002	WO				N	Y
<i>V</i>	B47	02/47168	06/13/2002	WO				N	Y
<i>TG</i>	B48	03/015140	02/20/2003	WO				N	Y

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	C2	Armstrong, "Technology for SiGe Heterostructure-Based CMOS Devices," PhD Thesis, Massachusetts Institute of Technology, 1999, pp. 1-154.
	C3	Augusto <i>et al.</i> , "Proposal for a New Process Flow for the Fabrication of Silicon-Based Complementary MOD-MOSFETs without Ion Implantation," <u>Thin Solid Films</u> , Vol. 294, No. 1-2 (February 15, 1997), pp. 254-258.
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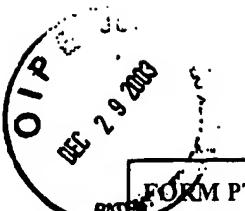
EXAMINER *Kevin Rinkos* DATE CONSIDERED *2/5/07*



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OTHER ART, JOURNAL ARTICLES, ETC.		
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EXAM. INIT.	OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)	
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